

### **Data Sheet**

### FEATURES

Low power, smallest pin-compatible, dual nanoDAC AD5663R: 16 bits AD5643R: 14 bits AD5623R: 12 bits User-selectable external or internal reference External reference default On-chip 1.25 V/2.5 V, 5 ppm/°C reference 10-lead MSOP and 3 mm × 3 mm LFCSP 2.7 V to 5.5 V power supply Guaranteed monotonic by design Power-on reset to zero scale Per channel power-down Serial interface up to 50 MHz Hardware LDAC and CLR functions

### APPLICATIONS

Process control Data acquisition systems Portable battery-powered instruments Digital gain and offset adjustment Programmable voltage and current sources Programmable attenuators

### **GENERAL DESCRIPTION**

The AD5623R/AD5643R/AD5663R, members of the *nano*DAC<sup>\*</sup> family, are low power, dual 12-, 14-, and 16-bit buffered voltageout digital-to-analog converters (DAC) that operate from a single 2.7 V to 5.5 V supply and are guaranteed monotonic by design.

The AD5623R/AD5643R/AD5663R have an on-chip reference. The AD5623R-3/AD5643R-3/AD5663R-3 have a 1.25 V, 5 ppm/°C reference, giving a full-scale output of 2.5 V; and the AD5623R-5/AD5643R-5/AD5663R-5 have a 2.5 V, 5 ppm/°C reference, giving a full-scale output of 5 V. The on-chip reference is off at power-up, allowing the use of an external reference; and all devices can be operated from a single 2.7 V to 5.5 V supply. The internal reference is turned on by writing to the DAC.

The parts incorporate a power-on reset circuit that ensures the DAC output powers up to 0 V and remains there until a valid write takes place. The part contains a power-down feature that reduces the current consumption of the device to 480 nA at 5 V and provides software-selectable output loads while in power-down mode.

Rev. G

**Document Feedback** 

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# Dual 12-/14-/16-Bit *nano*DAC with 5 ppm/°C On-Chip Reference

# AD5623R/AD5643R/AD5663R

### FUNCTIONAL BLOCK DIAGRAM



### Table 1. Related Devices

Part No.	Description
AD5663	2.7 V to 5.5 V, dual 16-bit <i>nano</i> DAC, with external
	reference

The low power consumption of this part in normal operation makes it ideally suited to portable, battery-operated equipment.

The AD5623R/AD5643R/AD5663R use a versatile, 3-wire serial interface that operates at clock rates up to 50 MHz, and they are compatible with standard SPI\*, QSPI<sup>™</sup>, MICROWIRE<sup>™</sup>, and DSP interface standards. The on-chip precision output amplifier enables rail-to-rail output swing to be achieved.

### **PRODUCT HIGHLIGHTS**

- 1. Dual 12-, 14-, and 16-bit DAC.
- 2. On-chip 1.25 V/2.5 V, 5 ppm/°C reference.
- 3. Available in 10-lead MSOP and 10-lead, 3 mm  $\times$  3 mm LFCSP.
- 4. Low power; typically consumes 0.6 mW at 3 V and 1.25 mW at 5 V.
- 5. 4.5  $\mu$ s maximum settling time for the AD5623R.

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### **REVISION HISTORY**

9/15—Rev. F to Rev. G	
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4/06—Revision 0: Initial Version

### **SPECIFICATIONS**

### AD5623R-5/AD5643R-5/AD5663R-5

 $V_{\text{DD}} = 4.5 \text{ V to } 5.5 \text{ V}; R_{\text{L}} = 2 \text{ } k\Omega \text{ to GND}; C_{\text{L}} = 200 \text{ pF to GND}; V_{\text{REFIN}} = V_{\text{DD}}; \text{all specifications } T_{\text{MIN}} \text{ to } T_{\text{MAX}}, \text{unless otherwise noted}.$ 

Table 2.

ParameterMinTypMaxMinTypMaxUnitConditions/CommentsSTATIC PERFORMANCE! <t< th=""><th></th><th></th><th>A Grade</th><th><sup>1</sup></th><th></th><th>B Grade</th><th><b>e</b><sup>1</sup></th><th></th><th></th></t<>			A Grade	<sup>1</sup>		B Grade	<b>e</b> <sup>1</sup>		
ADS663R Resolution Relative Accuracy Differential Nonlinearity16Bits $\pm 1$ Bits $\pm 1$ ADS643R Resolution Relative Accuracy Differential Nonlinearity14Bits $\pm 2$ 24LSB $\pm 0.55$ Guaranteed monotonic by designADS65281 Resolution Relative Accuracy Differential Nonlinearity14Bits $\pm 2$ 24LSB $\pm 0.55$ Guaranteed monotonic by designAD565281 Resolution Relative Accuracy Differential Nonlinearity12Bits $\pm 0.55$ Guaranteed monotonic by designAD565281 Resolution Offset Error $\pm 2$ $\pm 0.55$ $\pm 1$ LSB $\pm 0.55$ Guaranteed monotonic by designAD565281 Gain Error $\pm 1$ $\pm 2$ $\pm 0.55$ $\pm 1$ LSB $\pm 0.55$ Guaranteed monotonic by designAD565281 Gain Error $\pm 1$ $\pm 1$ $\pm 0.55$ $\pm 1$ LSB $\pm 0.55$ Guaranteed monotonic by designFull-Scale Error $\pm 1$ $\pm 1$ $-0.1$ $\pm 1$ $\pm 0.55$ KI Is loaded to DAC registerFig $\pm 1.55$ $\pm 1.55$ $\pm 2.55$ $\pm 2.55$ $\mu W/CC$ Gain Error $\pm 1.5$ $\pm 2.5$ $\pm 2.5$ $\mu W/CC$ DC Crosstalk (External Reference) $10$ $10$ $\mu W$ $\mu E$ No for KangeDC Crosstalk (Internal Reference) $20$ $20$ $20$ $\mu W$ $\mu E$ No for V <sub>10</sub> DC Crosstalk (Internal Reference) $20$ $V_{00}$ $\Psi$ $\Psi$ $\Psi$ Lo to Iul-scale output change; $R_{1} = 2.40$ DC Crosstalk (Internal Reference) $20$ <t< th=""><th>Parameter</th><th>Min</th><th>Тур</th><th>Max</th><th>Min</th><th>Тур</th><th>Max</th><th>Unit</th><th>Conditions/Comments</th></t<>	Parameter	Min	Тур	Max	Min	Тур	Max	Unit	Conditions/Comments
$ \begin{array}{ c c c c c } \hline Resolution \\ Relative Accuracy \\ Differential Nonlinearity \\ ADSc543R \\ Resolution \\ Relative Accuracy \\ Resolution \\ Relative Accuracy \\ \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	STATIC PERFORMANCE <sup>2</sup>								
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$ \begin{array}{ c c c c c } \mbox{Differential Nonlinearity} \\ ADS643R \\ Resolution \\ Relative Accuracy \\ Differential Nonlinearity \\ ADS623 \\ Resolution \\ Re$	Resolution				16			Bits	
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Relative Accuracy Differential Nonlinearity $= 12$ $\pm 4$ $\pm 50$ $\pm 50$ $\pm 50$ $\pm 10$ $\pm 50$ $\pm 50$ $\pm 10$ $\pm 50$ $\pm 10$ <td>AD5643R</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td>	AD5643R								
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AD5623R Resolution Relative Accuracy Differential Nonlinearity12Image: transform of the second	Relative Accuracy					±2	±4	LSB	
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Relative Accuracy Differential Nonlinearity $\pm 1$ $\pm 2$ $\pm 0.5$ $\pm 1$ LSB $\pm 0.25$ LSB LSBGuarateed monotonic by design All 0s loaded to DAC registerZero-Scale Error $\pm 1$ $\pm 10$ $\pm 1$ $\pm 10$ $mV$ All 0s loaded to DAC registerOffset Error $\pm 1$ $\pm 10$ $\pm 1$ $mV$ All 1s loaded to DAC registerFull-Scale Error Drift $\pm 1$ $\pm 1.5$ $-0.1$ $\pm 1$ $\% 0^{\circ}$ All 1s loaded to DAC registerGain Error $\pm 1.5$ $\pm 1.5$ $-0.1$ $\pm 1.5$ $\% 0^{\circ}$ FSRZero-Scale Error Drift $\pm 2$ $\pm 2$ $\pm 2$ $\mu V$ $\mu V^{\circ}C$ Gain Temperature Coefficient $\pm 2.5$ $-100$ $\mu V$ $\mu V^{\circ}C$ DC Power Supply Rejection Ratio $-100$ $-100$ $\mu V$ $\mu W$ $\mu Coefficient in 2.5DC Crosstalk (External Reference)10-100\mu W\mu V\mu V Due to full-scale output change;R_{L} = 2 k\Omega to GND or V_{D0}DC Crosstalk (Internal Reference)255\mu W\mu V mA\mu Ue to add current change0-10-10-10-10\mu W\mu U to ado current change;R_{L} = 2 k\Omega to GND or V_{D0}DC Crosstalk (Internal Reference)25-5\mu W\mu U to ado current change;R_{L} = 2 k\Omega to GND or V_{D0}DC Utput Voltage Range0V_{D0}20\mu W\mu U to ado current change;R_{L} = 2 k\Omega COutput Voltage Range0V_{D0}-10$	AD5623R								
$\begin{array}{cccccccc} \mbox{Differential Nonlinearity} & \pm 1 & \pm 1 & \pm 1 & \pm 0 & \pm 0.25 & LSB & Guaranteed monotonic by design & All 0s loaded to DAC register & MV & All 0s loaded to DAC register & MV & H10 & MV & All 1s loaded to DAC register & MV & H15 & -0.1 & \pm 1 & 0 & MV & FSR & -0.1 & \pm 1 & -0.1 & \pm 1 & MV & H1 & 1s loaded to DAC register & FSR & -1 & -0.1 & \pm 1 & MV & MV & -0.1 & \pm 1.5 & MV & MV & -0.1 & \pm 1.5 & MV & MV & -0.1 & \pm 1.5 & MV & MV & -0.1 & \pm 1.5 & MV & MV & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 & -0.1 & -0.1 & -0.1 & \pm 1.5 & MV & -0.1 $	Resolution				12			Bits	
$\begin{array}{cccccccccccccccccccccccccccccccccccc$	Relative Accuracy		±1	±2		±0.5	±1	LSB	
Offset Error $\pm 1$ $\pm 10$ $\pm 1$ $\pm 10$ $mV$ All 1s loaded to DAC registerFull-Scale Error $-0.1$ $\pm 1.5$ $-0.1$ $\pm 1.5$ $\% of$ All 1s loaded to DAC registerGain Error $\pm 1.5$ $\pm 1.5$ $\pm 1.5$ $\% of$ FSR $FSR$ Zero-Scale Error Drift $\pm 2.5$ $\pm 2.5$ $\pm 1.5$ $\mu V / ^{\circ}C$ DCGain Temperature Coefficient $\pm 2.5$ $\pm 2.5$ $\mu V / ^{\circ}C$ DAC code = midscale; $V_{DD} = 5 V \pm 10\%$ DC Power Supply Rejection Ratio $-100$ $-100$ $-100$ $\mu V$ Due to full-scale output change; $R_{I} = 2 k\Omega to GND or V_{DD}$ DC Crosstalk (External Reference) $10$ $-100$ $\mu V$ Due to load current changeDC Crosstalk (Internal Reference) $25$ $25$ $\mu V$ Due to full-scale output change; $R_{I} = 2 k\Omega to GND or V_{DD}$ DC Crosstalk (Internal Reference) $20$ $20$ $20$ $\mu V$ Due to full-scale output change; $R_{I} = 2 k\Omega to GND or V_{DD}$ OUTPUT CHARACTERISTICS3 $0$ $V_{DD}$ $0$ $V_{DD}$ $\mu V$ Due to powering down (per channel)OUTPUT GLARACTERISTICS3 $0$ $V_{DD}$ $10$ $nF$ $R_{I} = \infty$ Output Voltage Range $0$ $V_{DD}$ $2$ $nF$ $R_{I} = \infty$ DC Output Impedance $0.5$ $0.5$ $0.5$ $0.5$ $0.5$ Short-Circuit Current $30.5$ $30.5$ $mA$ $V_{DD} = 5V$ Power-Up Time $4$ $4$ $\mu s$ $\mu s$ $\mu s$ <td< td=""><td>Differential Nonlinearity</td><td></td><td></td><td>±1</td><td></td><td></td><td>±0.25</td><td>LSB</td><td>Guaranteed monotonic by design</td></td<>	Differential Nonlinearity			±1			±0.25	LSB	Guaranteed monotonic by design
Full-Scale ErrorImage: Constraint of the second secon	Zero-Scale Error		+2	+10		+2	+10	mV	All 0s loaded to DAC register
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Offset Error		±1	±10		±1	±10	mV	
$ \begin{array}{ c c c c } \mbox{Gain Error Drift} & & & & & & & & & & & & & & & & & & &$	Full-Scale Error		-0.1	±1		-0.1	±1	% of	All 1s loaded to DAC register
$ \begin{array}{ c c c c } \mbox{Zero-Scale Error Drift} & \pm 2 & \pm 2 & \pm 2 & \mu V'' C & \mu V'' C \\ \hline \mbox{Gain Temperature Coefficient} & \pm 2.5 & \pm 2.5 & \mu V' & D \\ \mbox{DC Power Supply Rejection Ratio} & -100 & -100 & -100 & dB & DAC code = midscale ; V_{DD} = 5 V \pm 10\% & DC Code = midscale ; V_{DD} = 5 V \pm 10\% & DC Code = midscale ; V_{DD} = 5 V \pm 10\% & DC Code = midscale ; V_{DD} = 5 V \pm 10\% & DC Code = midscale ; V_{DD} = 5 V \pm 10\% & DC Code = midscale ; V_{DD} = 5 V \pm 10\% & DUe to full-scale output change; RL = 2 k\Omega to GND or V_{DD} & RL = 2 k\Omega to GND or V_{DD} & Ue to load current change & \mu V & Due to load current change & DC Crosstalk (Internal Reference) & 25 & 5 & \mu V & Due to full-scale output change; RL = 2 k\Omega to GND or V_{DD} & DC Crosstalk (Internal Reference) & 25 & 25 & \mu V & Due to full-scale output change; RL = 2 k\Omega to GND or V_{DD} & Ue to load current change & \mu V & Due to load current change & 0 & V_{DD} & 0 & V_{DD} & Ue to load current change & 0 & V_{DD} & 0 & V_{DD} & 0 & V_{DD} & DUe to powering down (per channel) & 0 & 0 & V_{DD} & 0 & 0 & V_{DD} & DUe to powering down (per channel) & UV & Due to powering down (per channel) & UV & Due to powering down (per channel) & UV & Due to load current change & 0 & V_{DD} & 0 & V_{DD} & V_{D} & RL = 2 k\Omega & Goning out of power-down mode; & V_{DD} = 5 V & Short-Circuit Current & 30 & & 30 & & mA & V_{DD} = 5 V & Short-Circuit Current & 30 & & & MA & V_{DD} = 5 V & Short-Circuit Current & 170 & 200 & 170 & 200 & \mu A & V_{BD} = 5.5 V & Short-Circuit Reference Current & 170 & 200 & 170 & V_{DD} & V_{D} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_{DD} & V & V & Short-Circuit Current & 170 & 200 & 170 & V_$								FSR	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Gain Error			±1.5			±1.5		
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $								_	
$ \begin{array}{cccc} DC \mbox{ Power Supply Rejection Ratio} & -100 & -100 & dB & DAC \mbox{ Code = midscale ; V_{DD} = 5 V \pm 10\% & 1$						±2		μV/°C	
$ \begin{array}{cccc} 10^{\circ} & 1$	•								
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	DC Power Supply Rejection Ratio		-100			-100		dB	
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	DC Crosstalk (External Reference)		10			10		μV	
$ \begin{array}{cccc} DC \ Crosstalk \ (Internal \ Reference) \\ DC \ Crosstalk \ (Internal \ Reference) \\ 25 \\ 20 \\ 20 \\ 20 \\ 10 \\ \end{array} \\ \begin{array}{ccccc} 20 \\ 20 \\ 10 \\ \end{array} \\ \begin{array}{cccccc} 20 \\ 20 \\ 10 \\ \end{array} \\ \begin{array}{cccccccc} 20 \\ 20 \\ 10 \\ \end{array} \\ \begin{array}{ccccccccccccccccccccccccccccccccccc$			10			10		μV/mA	Due to load current change
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$			5			5		μV	Due to powering down (per channel)
$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	DC Crosstalk (Internal Reference)		25			25		μV	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $			20			20		µV/mA	
OUTPUT CHARACTERISTICS3 Output Voltage Range0 $V_{DD}$ 0 $V_{DD}$ VCapacitive Load Stability22nF $R_L = \infty$ 1010nF $R_L = 2 k\Omega$ DC Output Impedance0.50.5 $\Omega$ Short-Circuit Current3030mA $V_{DD} = 5 V$ Power-Up Time44 $\mu s$ Coming out of power-down mode; $V_{DD} = 5 V$ REFERENCE INPUTS170200170200 $\mu A$ Reference Current0.75 $V_{DD}$ 0.75 $V_{DD}$ $V$			10			10			5
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	OUTPUT CHARACTERISTICS <sup>3</sup>								
$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	Output Voltage Range	0		V <sub>DD</sub>	0		V <sub>DD</sub>	v	
$ \begin{array}{cccc} DC \ Output \ Impedance & 0.5 & 0.5 & \Omega & MA & V_{DD} = 5 \ V & V_{DD} & V \ V & V_{DD} & V \ V & V_{DD} & V \ V & V_{DD} = 5 \ $			2			2		nF	$R_{L} = \infty$
Short-Circuit Current Power-Up Time3030mA $V_{DD} = 5 V$ REFERENCE INPUTS Reference Current Reference Input Range170200170200 $\mu A$ $V_{REF} = V_{DD} = 5.5 V$			10			10		nF	$R_L = 2 k\Omega$
Short-Circuit Current Power-Up Time3030mA $V_{DD} = 5 V$ REFERENCE INPUTS Reference Current Reference Input Range170200170200 $\mu A$ $V_{REF} = V_{DD} = 5.5 V$	DC Output Impedance							Ω	
REFERENCE INPUTS         Image         170         200         170         200         μA         V <sub>DD</sub> = 5.V           Reference Current         170         200         170         200         μA         V <sub>REF</sub> = V <sub>DD</sub> = 5.5 V           Reference Input Range         0.75         V <sub>DD</sub> 0.75         V <sub>DD</sub> V									$V_{DD} = 5 V$
Reference Current         170         200         170         200         μA         V <sub>REF</sub> = V <sub>DD</sub> = 5.5 V           Reference Input Range         0.75         V <sub>DD</sub> 0.75         V <sub>DD</sub> V	Power-Up Time		4			4		μs	
Reference Current         170         200         170         200         μA         V <sub>REF</sub> = V <sub>DD</sub> = 5.5 V           Reference Input Range         0.75         V <sub>DD</sub> 0.75         V <sub>DD</sub> V	REFERENCE INPUTS	1			1				
Reference Input Range0.75VDD0.75VDDV			170	200		170	200	μA	$V_{\text{REF}} = V_{\text{DD}} = 5.5 \text{ V}$
		0.75			0.75			-	
	Reference Input Impedance		26			26		kΩ	

# **Data Sheet**

# AD5623R/AD5643R/AD5663R

	A Grade <sup>1</sup>			<b>B</b> Grade <sup>1</sup>				
Parameter	Min	Тур	Max	Min	Тур	Max	Unit	<b>Conditions/Comments</b>
REFERENCE OUTPUT								
Output Voltage	2.495		2.505	2.495		2.505	V	At ambient
Reference Temperature Coefficient <sup>3</sup>		±10			±5	±10	ppm/°C	MSOP package models
		±10			±10		ppm/°C	LFCSP package models
Output Impedance		7.5			7.5		kΩ	
LOGIC INPUTS <sup>3</sup>								
Input Current			±2			±2	μA	All digital inputs
Input Low Voltage (V <sub>INL</sub> )			0.8			0.8	V	$V_{DD} = 5 V$
Input High Voltage (V <sub>INH</sub> )	2			2			V	$V_{DD} = 5 V$
Pin Capacitance		3			3		pF	DIN, SCLK, and SYNC
		19			19		pF	LDAC and CLR
POWER REQUIREMENTS								
V <sub>DD</sub>	4.5		5.5	4.5		5.5	V	
I <sub>DD</sub> (Normal Mode) <sup>4</sup>								$V_{IH} = V_{DD}$ and $V_{IL} = GND$
$V_{DD} = 4.5 V \text{ to } 5.5 V$		0.25	0.45		0.25	0.45	mA	Internal reference off
$V_{DD} = 4.5 V \text{ to } 5.5 V$		0.8	1		0.8	1	mA	Internal reference on
I <sub>DD</sub> (All Power-Down Modes)⁵								
$V_{DD} = 4.5 \text{ V}$ to 5.5 V		0.48	1		0.48	1	μA	$V_{IH} = V_{DD}$ and $V_{IL} = GND$

<sup>1</sup> Temperature range: A, B grade = -40°C to +105°C. <sup>2</sup> Linearity calculated using a reduced code range: AD5663R (Code 512 to Code 65,024), AD5643R (Code 128 to Code 16,256), and AD5623R (Code 32 to Code 4064). <sup>3</sup> Guaranteed by design and characterization, not production tested. <sup>4</sup> Interface inactive. All DACs active. DAC outputs unloaded. <sup>5</sup> Both DACs powered down.

 $V_{DD}$  = 2.7 V to 3.6 V;  $R_L$  = 2 k $\Omega$  to GND;  $C_L$  = 200 pF to GND;  $V_{REFIN}$  =  $V_{DD}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

		B Grade	<b>e</b> <sup>1</sup>		
Parameter	Min	Тур	Max	Unit	Conditions/Comments
STATIC PERFORMANCE <sup>2</sup>					
AD5663R					
Resolution	16			Bits	
Relative Accuracy		±8	±16	LSB	
Differential Nonlinearity			±1	LSB	Guaranteed monotonic by design
AD5643R					
Resolution	14			Bits	
Relative Accuracy		±2	±4	LSB	
Differential Nonlinearity			±0.5	LSB	Guaranteed monotonic by design
AD5623R					
Resolution	12			Bits	
Relative Accuracy		±0.5	±1	LSB	
Differential Nonlinearity			±0.25	LSB	Guaranteed monotonic by design
Zero-Scale Error		+2	+10	mV	All 0s loaded to DAC register
Offset Error		±1	±10	mV	
Full-Scale Error		-0.1	±1	% of FSR	All 1s loaded to DAC register
Gain Error			±1.5	% of FSR	
Zero-Scale Error Drift		±2		μV/°C	
Gain Temperature Coefficient		 ±2.5		ppm	Of FSR/°C
DC Power Supply Rejection Ratio		-100		dB	DAC code = midscale; $V_{DD} = 3 V \pm 10\%$
DC Crosstalk (External Reference)		10		μV	Due to full-scale output change;
				P	$R_L = 2 k\Omega$ to GND or $V_{DD}$
		10		μV/mA	Due to load current change
		5		μV	Due to powering down (per channel)
DC Crosstalk (Internal Reference)		25		μV	Due to full-scale output change;
					$R_L = 2 k\Omega$ to GND or $V_{DD}$
		20		μV/mA	Due to load current change
		10		μV	Due to powering down (per channel)
OUTPUT CHARACTERISTICS <sup>3</sup>					
Output Voltage Range	0		VDD	V	
Capacitive Load Stability		2		nF	$R_L = \infty$
		10		nF	$R_L = 2 k\Omega$
DC Output Impedance		0.5		Ω	
Short Circuit Current		30		mA	$V_{DD} = 3 V$
Power-Up Time		4		μs	Coming out of power-down mode; $V_{DD} = 3 V$
REFERENCE INPUTS					
Reference Current		170	200	μΑ	$V_{REF} = V_{DD} = 3.6 V$
Reference Input Range	0.75		V <sub>DD</sub>	V	
Reference Input Impedance	-	26		kΩ	
REFERENCE OUTPUT					
Output Voltage	1.247		1.253	v	At ambient
Reference Temperature Coefficient <sup>3</sup>		±5	±15	ppm/°C	MSOP package models
		±10		ppm/°C	LFCSP package models
Output Impedance		7.5		kΩ	
output impedance		,		1122	

		B Grad	e <sup>1</sup>		
Parameter	Min	Тур	Max	Unit	Conditions/Comments
LOGIC INPUTS <sup>3</sup>					
Input Current			±2	μA	All digital inputs
V <sub>INL</sub> , Input Low Voltage			0.8	V	$V_{DD} = 3 V$
V <sub>INH</sub> , Input High Voltage	2			V	$V_{DD} = 3 V$
Pin Capacitance		3		pF	DIN, SCLK, and SYNC
		19		pF	LDAC and CLR
POWER REQUIREMENTS					
V <sub>DD</sub>	2.7		3.6	V	
I <sub>DD</sub> (Normal Mode)⁴					$V_{IH} = V_{DD}$ and $V_{IL} = GND$
$V_{DD} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$		200	425	μΑ	Internal reference off
$V_{DD} = 2.7 \text{ V to } 3.6 \text{ V}$		800	900	μΑ	Internal reference on
I <sub>DD</sub> (All Power-Down Modes)⁵					
$V_{DD} = 2.7 \text{ V to } 3.6 \text{ V}$		0.2	1	μΑ	$V_{IH} = V_{DD}$ and $V_{IL} = GND$

<sup>1</sup> Temperature range: B grade =  $-40^{\circ}$ C to  $+105^{\circ}$ C.

<sup>2</sup> Linearity calculated using a reduced code range: AD5663R (Code 512 to Code 65,024), AD5643R (Code 128 to Code 16,256), and AD5623R (Code 32 to Code 4064). Output unloaded.

<sup>3</sup> Guaranteed by design and characterization, not production tested.

<sup>4</sup> Interface inactive. All DACs active. DAC outputs unloaded.
 <sup>5</sup> Both DACs powered down.

### **AC CHARACTERISTICS**

 $V_{DD} = 2.7 \text{ V}$  to 5.5 V;  $R_L = 2 \text{ k}\Omega$  to GND;  $C_L = 200 \text{ pF}$  to GND;  $V_{REFIN} = V_{DD}$ ; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Parameter <sup>1, 2</sup>	Min	Тур	Max	Unit	Conditions/Comments <sup>3</sup>
Output Voltage Settling Time		19P	Mux		Conditions/ conments
AD5623R		3	4.5		$\frac{1}{4}$ to $\frac{3}{4}$ scale settling to ±0.5 LSB
				μs	5
AD5643R		3.5	5	μs	$\frac{1}{4}$ to $\frac{3}{4}$ scale settling to $\pm 0.5$ LSB
AD5663R		4	7	μs	$\frac{1}{4}$ to $\frac{3}{4}$ scale settling to $\pm 2$ LSB
Slew Rate		1.8		V/µs	
Digital-to-Analog Glitch Impulse		10		nV-sec	1 LSB change around major carry
Digital Feedthrough		0.1		nV-sec	
Reference Feedthrough		-90		dB	$V_{REF} = 2 V \pm 0.1 V p$ -p, frequency 10 Hz to 20 MHz
Digital Crosstalk		0.1		nV-sec	
Analog Crosstalk		1		nV-sec	External reference
		4		nV-sec	Internal reference
DAC-to-DAC Crosstalk		1		nV-sec	External reference
		4		nV-sec	Internal reference
Multiplying Bandwidth		340		kHz	$V_{\text{REF}} = 2 \text{ V} \pm 0.1 \text{ V} \text{ p-p}$
Total Harmonic Distortion		-80		dB	$V_{REF} = 2 V \pm 0.1 V p$ -p, frequency = 10 kHz
Output Noise Spectral Density		120		nV/√Hz	DAC code = midscale, 1 kHz
		100		nV/√Hz	DAC code = midscale, 10 kHz
Output Noise		15		μV p-p	0.1 Hz to 10 Hz

<sup>1</sup> Guaranteed by design and characterization, not production tested.

<sup>2</sup> See the Terminology section.

<sup>3</sup> Temperature range: A, B grade =  $-40^{\circ}$ C to  $+105^{\circ}$ C, typical at  $+25^{\circ}$ C.

### TIMING CHARACTERISTICS

All input signals are specified with  $t_R = t_F = 1$  ns/V (10% to 90% of  $V_{DD}$ ) and timed from a voltage level of  $(V_{IL} + V_{IH})/2$ .  $V_{DD} = 2.7$  V to 5.5 V; all specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.<sup>1</sup>

#### Table 5.

	Limit at T <sub>MIN</sub> , T <sub>MAX</sub>					
Parameter	$V_{DD} = 2.7 V \text{ to } 5.5 V$	Unit	Conditions/Comments			
t1 <sup>2</sup>	20	ns min	SCLK cycle time			
t <sub>2</sub>	9	ns min SCLK high time				
t <sub>3</sub>	9	ns min	SCLK low time			
t4	13	ns min	SYNC to SCLK falling edge setup time			
t5	5	ns min	Data setup time			
t <sub>6</sub>	5	ns min	Data hold time			
t7	0	ns min	SCLK falling edge to SYNC rising edge			
t <sub>8</sub>	15	ns min	Minimum SYNC high time			
t9	13	ns min	SYNC rising edge to SCLK fall ignore			
t <sub>10</sub>	0	ns min	SCLK falling edge to SYNC fall ignore			
t11	10	ns min	LDAC pulse width low			
t <sub>12</sub>	15	ns min	SCLK falling edge to LDAC rising edge			
t <sub>13</sub>	5	ns min	CLR pulse width low			
t <sub>14</sub>	0	ns min	SCLK falling edge to LDAC falling edge			
t <sub>15</sub>	300	ns max	CLR pulse activation time			

<sup>1</sup> Guaranteed by design and characterization, not production tested.

<sup>2</sup> Maximum SCLK frequency is 50 MHz at  $V_{DD} = 2.7$  V to 5.5 V.

### **TIMING DIAGRAM**



Figure 2. Serial Write Operation

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}$ C, unless otherwise noted.

### Table 6.

Parameter	Rating
V <sub>DD</sub> to GND	–0.3 V to +7 V
Vout to GND	-0.3 V to V <sub>DD</sub> + 0.3 V
V <sub>REFIN</sub> /V <sub>REFOUT</sub> to GND	-0.3 V to V <sub>DD</sub> + 0.3 V
Digital Input Voltage to GND	-0.3 V to V <sub>DD</sub> + 0.3 V
Operating Temperature Range	
Industrial	-40°C to +105°C
Storage Temperature Range	-65°C to +150°C
Junction Temperature (TJ max)	150°C
Power Dissipation	$(T_J max - T_A)/\theta_{JA}$
LFCSP Package (4-Layer Board)	
$\theta_{JA}$ Thermal Impedance	61°C/W
MSOP Package (4-Layer Board)	
$\theta_{JA}$ Thermal Impedance	142°C/W
$\theta_{JC}$ Thermal Impedance	43.7°C/W
Reflow Soldering Peak Temperature	
Pb-Free	260(+0/-5)°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**



### Table 7. Pin Function Descriptions

Pin No.	Mnemonic	Description
1	VoutA	Analog Output Voltage from DAC A. The output amplifier has rail-to-rail operation.
2	VoutB	Analog Output Voltage from DAC B. The output amplifier has rail-to-rail operation.
3	GND	Ground. Reference point for all circuitry on the part.
4	LDAC	Pulsing this pin low allows any or all DAC registers to be updated if the input registers have new data. This allows simultaneous update of all DAC outputs. Alternatively, this pin can be tied permanently low.
5	CLR	Asynchronous Clear Input. The CLR input is falling edge sensitive. While CLR is low, all LDAC pulses are ignored. When CLR is activated, zero scale is loaded to all input and DAC registers. This clears the output to 0 V. The part exits clear code mode on the 24th falling edge of the next write to the part. If CLR is activated during a write sequence, the write is aborted.
6	SYNC	Level-Triggered Control Input (Active Low). This is the frame synchronization signal for the input data. When SYNC goes low, it enables the input shift register, and data is transferred in on the falling edges of the following clocks. The DAC is updated following the 24th clock cycle unless SYNC is taken high before this edge, in which case the rising edge of SYNC acts as an interrupt and the write sequence is ignored by the DAC.
7	SCLK	Serial Clock Input. Data is clocked into the input shift register on the falling edge of the serial clock input. Data can be transferred at rates up to 50 MHz.
8	DIN	Serial Data Input. This device has a 24-bit shift register. Data is clocked into the register on the falling edge of the serial clock input.
9	V <sub>DD</sub>	Power Supply Input. These parts can be operated from 2.7 V to 5.5 V, and the supply should be decoupled with a 10 $\mu F$ capacitor to GND.
10	VREFIN/VREFOUT	Common Reference Input/Reference Output. When the internal reference is selected, this is the reference output pin. When using an external reference, this is the reference input pin. The default for this pin is a reference input.

0.2 0

-0.2

-0.4

-0.6

-0.8 -1.0

0

0.5k

mmm

1.0k

1.5k

2.0k

Figure 6. INL—AD5623R, External Reference

CODE

2.5k

3.0k

3.5k

# AD5623R/AD5643R/AD5663R

### **TYPICAL PERFORMANCE CHARACTERISTICS**





w

05858-007

4.0k



### Data Sheet















Figure 28. Zero-Scale Error and Offset Error vs. Supply







Figure 30. IDD Histogram with Internal Reference





Figure 32. AD5623R-5/AD5643R-5/AD5663R-5 Source and Sink Capability



Figure 33. AD5623R-3/AD5643R-3/AD5663R-3 Source and Sink Capability

5858-062

85

5858

512

512



### **Data Sheet**



Figure 40. Analog Crosstalk, Internal Reference



Figure 41. 0.1 Hz to 10 Hz Output Noise Plot, External Reference



Figure 42. 0.1 Hz to 10 Hz Output Noise Plot, Internal Reference



Figure 43. 0.1 Hz to 10 Hz Output Noise Plot, Internal Reference









### TERMINOLOGY

#### Relative Accuracy or Integral Nonlinearity (INL)

For the DAC, relative accuracy or integral nonlinearity is a measurement of the maximum deviation, in LSBs, from a straight line passing through the endpoints of the DAC transfer function. A typical INL vs. code plot is shown in Figure 5.

#### Differential Nonlinearity (DNL)

Differential nonlinearity (DNL) is the difference between the measured change and the ideal 1 LSB change between any two adjacent codes. A specified differential nonlinearity of  $\pm$ 1 LSB maximum ensures monotonicity. This DAC is guaranteed monotonic by design. A typical DNL vs. code plot is shown in Figure 9.

### Zero-Scale Error

Zero-scale error is the measurement of the output error when zero code (0x0000) is loaded to the DAC register. Ideally, the output should be 0 V. The zero-scale error is always positive in the AD5623R/AD5643R/AD5663R because the output of the DAC cannot go below 0 V. It is due to a combination of the offset errors in the DAC and the output amplifier. Zero-scale error is expressed in mV. A plot of zero-scale error vs. temperature is shown in Figure 26.

#### **Full-Scale Error**

Full-scale error is the measurement of the output error when full-scale code (0xFFFF) is loaded into the DAC register. Ideally, the output should be  $V_{\rm DD} - 1$  LSB. Full-scale error is expressed in percent of full-scale range. A plot of full-scale error vs. temperature is shown in Figure 25.

### Gain Error

Gain error is a measure of the span error of the DAC. It is the deviation in slope of the DAC transfer characteristic from ideal, expressed as a percent of the full-scale range.

#### Zero-Scale Error Drift

Zero-scale error drift is the measurement of the change in zero-scale error with a change in temperature. It is expressed in microvolts/°C ( $\mu$ V/°C).

#### **Gain Temperature Coefficient**

Gain temperature coefficient is a measurement of the change in gain error with changes in temperature. It is expressed in (ppm of full-scale range)/°C.

#### **Offset Error**

Offset error is a measure of the difference between  $V_{OUT}$  (actual) and  $V_{OUT}$  (ideal) expressed in mV in the linear region of the transfer function. Offset error is measured on the AD5623R/AD5643R/AD5663R with code 512 loaded in the DAC register. It can be negative or positive.

#### DC Power Supply Rejection Ratio (PSRR)

PSRR indicates how the output of the DAC is affected by changes in the supply voltage. PSRR is the ratio of the change in VOUT to a change in VDD for full-scale output of the DAC. It is measured in dB. VREF is held at 2 V, and VDD is varied by  $\pm 10\%$ .

#### **Output Voltage Settling Time**

Output voltage settling time is the amount of time it takes for the output of a DAC to settle to a specified level for a 1/4 to 3/4 full-scale input change and is measured from the 24th falling edge of SCLK.

#### Digital-to-Analog Glitch Impulse

The impulse injected into the analog output when the input code in the DAC register changes state. It is normally specified as the area of the glitch in nV-sec and is measured when the digital input code is changed by 1 LSB at the major carry transition (0x7FFF to 0x8000). See Figure 38.

### **Digital Feedthrough**

A measure of the impulse injected into the analog output of the DAC from the digital inputs of the DAC, digital feedthrough is measured when the DAC output is not updated. It is specified in nV-sec, and it is measured with a full-scale code change on the data bus, that is, from all 0s to all 1s and vice versa.

#### **Reference Feedthrough**

Reference feedthrough is the ratio of the amplitude of the signal at the DAC output to the reference input when the DAC output is not being updated (that is,  $\overline{\text{LDAC}}$  is high). It is expressed in decibels (dB).

#### **Noise Spectral Density**

Noise spectral density is a measurement of the internally generated random noise. Random noise is characterized as a spectral density ( $nV/\sqrt{Hz}$ ). It is measured by loading the DAC to midscale and measuring noise at the output. A plot of noise spectral density is shown in Figure 44.

#### DC Crosstalk

DC crosstalk is the dc change in the output level of one DAC in response to a change in the output of another DAC. It is measured with a full-scale output change on one DAC (or soft power-down and power-up) while monitoring another DAC kept at midscale. It is expressed in microvolts ( $\mu$ V).

DC crosstalk due to load current change is a measure of the impact that a change in load current on one DAC has to another DAC kept at midscale. It is expressed in microvolts/ milliamps ( $\mu$ V/mA).

#### **Digital Crosstalk**

Digital crosstalk is the glitch impulse transferred to the output of one DAC at midscale in response to a full-scale code change (all 0s to all 1s and vice versa) in the input register of another DAC. It is measured in standalone mode and is expressed in nanovolts-second (nV-sec).

### Analog Crosstalk

Analog crosstalk is the glitch impulse transferred to the output of one DAC due to a change in the output of another DAC. It is measured by loading one of the input registers with a full-scale code change (all 0s to all 1s and vice versa) while keeping LDAC high. Then pulse  $\overline{\text{LDAC}}$  low and monitor the output of the DAC whose digital code was not changed. The area of the glitch is expressed in nanovolts-second (nV-sec).

### DAC-to-DAC Crosstalk

DAC-to-DAC crosstalk is the glitch impulse transferred to the output of one DAC due to a digital code change and subsequent output change of another DAC. This includes both digital and analog crosstalk. It is measured by loading one of the DACs with a full-scale code change (all 0s to all 1s and vice versa) with  $\overline{\text{LDAC}}$  low and monitoring the output of another DAC. The energy of the glitch is expressed in nanovolts-second (nV-sec).

### Multiplying Bandwidth

The amplifiers within the DAC have a finite bandwidth. The multiplying bandwidth is a measure of this. A sine wave on the reference (with full-scale code loaded to the DAC) appears on the output. The multiplying bandwidth is the frequency at which the output amplitude falls to 3 dB below the input.

### **Total Harmonic Distortion (THD)**

Total harmonic distortion is the difference between an ideal sine wave and its attenuated version using the DAC. The sine wave is used as the reference for the DAC, and the THD is a measurement of the harmonics present on the DAC output. It is measured in decibels (dB).

# THEORY OF OPERATION

### DIGITAL-TO-ANALOG SECTION

The AD5623R/AD5643R/AD5663R DAC is fabricated on a CMOS process. The architecture consists of a string DAC followed by an output buffer amplifier. Figure 49 shows a block diagram of the DAC architecture.



Figure 49. DAC Architecture

Because the input coding to the DAC is straight binary, the ideal output voltage when using an external reference is given by

$$V_{OUT} = V_{REFIN} \times \left(\frac{D}{2^N}\right)$$

The ideal output voltage when using the internal reference is given by

$$V_{OUT} = 2 \times V_{REFOUT} \times \left(\frac{D}{2^{N}}\right)$$

where:

*D* is the decimal equivalent of the binary code that is loaded to the DAC register:

```
0 to 4095 for AD5623R (12-bit)
0 to 16,383 for AD5643R (14-bit)
0 to 65,535 for AD5663R (16-bit)
```

N is the DAC resolution.

### **RESISTOR STRING**

The resistor string section is shown in Figure 50. It is simply a string of resistors, each of Value R. The code loaded to the DAC register determines at which node on the string the voltage is tapped off to be fed into the output amplifier. The voltage is tapped off by closing one of the switches connecting the string to the amplifier. Because it is a string of resistors, it is guaranteed monotonic.

### **OUTPUT AMPLIFIER**

The output buffer amplifier can generate rail-to-rail voltages on its output, which gives an output range of 0 V to  $V_{\rm DD}$ . It can drive a load of 2 k $\Omega$  in parallel with 1000 pF to GND. The source and sink capabilities of the output amplifier can be seen in Figure 31. The slew rate is 1.8 V/µs with a 1/4 to 3/4 full-scale settling time of 10 µs.



### INTERNAL REFERENCE

The AD5623R/AD5643R/AD5663R on-chip reference is off at power-up and is enabled via a write to a control register. See the Internal Reference Setup section for details.

The AD5623R-3/AD5643R-3/AD5663R-3 has a 1.25 V, 5 ppm/°C reference, giving a full-scale output of 2.5 V. The AD5623R-5/AD5643R-5/AD5663R-5 has a 2.5 V, 5 ppm/°C reference, giving a full-scale output of 5 V. The internal reference associated with each part is available at the V<sub>REFOUT</sub> pin. A buffer is required if the reference output is used to drive external loads. When using the internal reference, it is recommended that a 100 nF capacitor be placed between reference output and GND for reference stability.

### **EXTERNAL REFERENCE**

The V<sub>REFIN</sub> pins on the AD5623R-3/AD5643R-3/AD5663R-3 and the AD5623R-5/AD5643R-5/AD5663R-5 allows the use of an external reference if the application requires it. The on-chip reference is off at power-up, and this is the default condition. The AD5623R-3/AD5643R-3/AD5663R-3 and the AD5623R-5/ AD5643R-5/AD5663R-5 can be operated from a single 2.7 V to 5.5 V supply.

### SERIAL INTERFACE

The AD5623R/AD5643R/AD5663R have a 3-wire serial interface (SYNC, SCLK, and DIN) that is compatible with SPI, QSPI, and MICROWIRE interface standards, as well as with most DSPs. See Figure 2 for a timing diagram of a typical write sequence.

The write sequence begins by bringing the SYNC line low. Data from the DIN line is clocked into the 24-bit shift register on the falling edge of SCLK. The serial clock frequency can be as high as 50 MHz, making the AD5623R/AD5643R/AD5663R compatible with high speed DSPs. On the 24th falling clock edge, the last data bit is clocked in and the programmed function is executed, for example, a change in DAC register contents and/or a change in the mode of operation.

At this stage, the  $\overline{\text{SYNC}}$  line can be kept low or be brought high. In either case, it must be brought high for a minimum of 15 ns before the next write sequence, so that a falling edge of  $\overline{\text{SYNC}}$  can initiate the next write sequence.

Because the  $\overline{SYNC}$  buffer draws more current when  $V_{\rm IN}=2~V$  than it does when  $V_{\rm IN}=0.8~V, \overline{SYNC}$  should be idled low between write sequences for even lower power operation. As mentioned previously, it must, however, be brought high again just before the next write sequence.

### **INPUT SHIFT REGISTER**

SCLK

SYNC

DIN

The input shift register is 24 bits wide (see Figure 52). The first two bits are don't cares. The next three are Command Bit C2 to Command Bit C0 (see Table 8), followed by the 3-bit DAC Address A2 to DAC Address A0 (see Table 9), and, finally, the 16-, 14-, and 12-bit data-word.

The data-word comprises the 16-, 14-, and 12-bit input codes, followed by zero, two, or four don't care bits, for the AD5663R, AD5643R, and AD5623R, respectively (see Figure 51, Figure 52, and Figure 53). The data bits are transferred to the DAC register on the 24th falling edge of SCLK.

### Table 8. Command Definition

C2	C1	С0	Command
0	0	0	Write to Input Register <i>n</i>
0	0	1	Update DAC Register <i>n</i>
0	1	0	Write to In <u>put R</u> egister <i>n</i> , update all (software LDAC)
0	1	1	Write to and update DAC Channel <i>n</i>
1	0	0	Power down DAC (power up)
1	0	1	Reset
1	1	0	LDAC register setup
1	1	1	Internal reference setup (on/off)

#### Table 9. Address Command

Tuble 9. Mailess Command									
A2	A1	A0	ADDRESS (n)						
0	0	0	DAC A						
0	0	1	DAC B						
0	1	0	Reserved						
0	1	1	Reserved						
1	1	1	All DACs						

### **SYNC INTERRUPT**

In a normal write sequence, the SYNC line is kept low for at least 24 falling edges of SCLK, and the DAC is updated on the 24th falling edge. However, if SYNC is brought high before the 24th falling edge, this acts as an interrupt to the write sequence. The shift register is reset, and the write sequence is seen as invalid. Neither an update of the DAC register contents nor a change in the operating mode occurs (see Figure 54).



### **POWER-ON RESET**

The AD5623R/AD5643R/AD5663R contain a power-on reset circuit that controls the output voltage during power-up. The AD5623R/AD5643R/AD5663R DACs output power up to 0 V, and the output remains there until a valid write sequence is made to the DACs. This is useful in applications where it is important to know the state of the output of the DACs while they are in the process of powering up. Any events on LDAC or CLR during power-on reset are ignored.

### SOFTWARE RESET

The AD5623R/AD5643R/AD5663R contain a software reset function. Command 101 is reserved for the software reset function (see Table 8). The software reset command contains two reset modes that are software-programmable by setting bit DB0 in the control register. Table 10 shows how the state of the bit corresponds to the mode of operation of the device. Table 12 shows the contents of the input shift register during the software reset mode of operation.

#### Table 10. Software Reset Modes

DB0	Registers Reset to Zero
0	DAC register
	Input register
1 (Power-on Reset)	DAC register
	Input register
	LDAC register
	Power-down register
	Internal reference setup register

After a full software reset (DB0 = 1), there must be a short time delay, approximately 5  $\mu$ s, to allow the reset to complete. During the reset, a low pulse can be observed on the  $\overline{\text{CLR}}$  line. If the next SPI transaction commences before the  $\overline{\text{CLR}}$  line returns high, that SPI transaction is ignored.

### **POWER-DOWN MODES**

The AD5623R/AD5643R/AD5663R contain four separate modes of operation. Command 100 is reserved for the power-down function (see Table 8). These modes are software-programmable by setting Bit DB5 and Bit DB4 in the control register. Table 11 shows how the state of the bits corresponds to the mode of operation of the device. Any or all DACs (DAC B and DAC A) can be powered down to the selected mode by setting the corresponding two bits (Bit DB1 and Bit DB0) to 1.

### AD5623R/AD5643R/AD5663R

By executing the same Command 100, any combination of DACs can be powered up by setting Bit DB5 and Bit DB4 to normal operation mode.

Again, to select which combination of DAC channels to power up, set the corresponding bits (Bit DB1 and Bit DB0) to 1. See Table 13 for contents of the input shift register during powerdown/power-up operation.

The DAC output powers up to the value in the input register while LDAC is low. If LDAC is high, the DAC output powers up to the value held in the DAC register before power-down.

Table 11. Modes of Operation							
DB5	DB4 Operating Mode						
0	0	Normal operation					
		Power-down modes					
0	1	1 kΩ to GND					
1	0	100 kΩ to GND					
1	1	Three-state					

When both Bit DB1 and Bit DB2 are set to 0, the part works normally, with its normal power consumption of 250  $\mu$ A at 5 V. However, for the three power-down modes, the supply current falls to 480 nA at 5 V (200 nA at 3 V). Not only does the supply current fall, but the output stage is also internally switched from the output of the amplifier to a resistor network of known values. This has the advantage that the output impedance of the part is known while the part is in power-down mode. The outputs can either be connected internally to GND through a 1 k $\Omega$  or 100 k $\Omega$  resistor or left open-circuited (three-state) (see Figure 55).



Figure 55. Output Stage During Power-Down

The bias generator, the output amplifier, the resistor string, and other associated linear circuitry are shut down when power-down mode is activated. However, the contents of the DAC register are unaffected when in power-down. The time to exit power-down is typically 4  $\mu$ s for both VDD = 5 V and VDD = 3 V (see Figure 37).

Table 12. 24-Bit Input Shift Register Contents for Software Reset Command MSB

MSB								LSB
DB23 to DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15 to DB1	DB0
x	1	0	1	Х	Х	Х	Х	1/0
Don't care	Command bits (C2 to C0)			Address b	oits (A2 to A	A0)	Don't care	Determines software reset mode

I SR

 Table 13. 24-Bit Input Shift Register Contents of Power Up/Down Function

MSB													LSB
DB23 to DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15 to DB6	DB5	DB4	DB3	DB2	DB1	DB0
х	1	0	0	Х	Х	Х	Х	PD1	PD0	Х	Х	DAC B	DAC A
Don't care	Command bits (C2 to C0)			Addres Don't c	s bits (A2 are	to A0)	Don't care	Power-down mode		Don't care		Power down/Power up channel selection; set bit to 1 to select channel	

Table 14. 24-Bit Input Shift Register Contents for LDAC Setup Command	
MSB	

IVI3D									L3D	
DB23 to DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15 to DB2	DB1	DB0	
х	1	1	0	Х	Х	Х	Х	DAC B	DAC A	
Don't care	Command bits (C2 to C0)			Address bits Don't care	s (A3 to A0)	-	Don't care	Set DAC to 0 or 1 for required mode of operation		

### **LDAC** FUNCTION

The AD5623R/AD5643R/AD5663R DACs have double-buffered interfaces consisting of two banks of registers: input registers and DAC registers. The input registers are connected directly to the input shift register, and the digital code is transferred to the relevant input register on completion of a valid write sequence. The DAC registers contain the digital code used by the resistor strings.

Access to the DAC registers is controlled by the LDAC pin. When the LDAC pin is high, the DAC registers are latched and the input registers can change state without affecting the contents of the DAC registers. When LDAC is brought low, however, the DAC registers become transparent and the contents of the input registers are transferred to them. The double-buffered interface is useful if the user requires simultaneous updating of all DAC outputs. The user can write to one of the input registers individually and then, by bringing LDAC low when writing to the other DAC input register, all outputs will update simultaneously.

These parts each contain an extra feature whereby a DAC register is not updated unless its input register has been updated since the last time LDAC was brought low. Normally, when LDAC is brought low, the DAC registers are filled with the contents of the input registers. In the case of the AD5623R/AD5643R/ AD5663R, the DAC register updates only if the input register has changed since the last time the DAC register was updated, thereby removing unnecessary digital crosstalk.

The outputs of all DACs can be simultaneously updated, using the hardware  $\overline{\text{LDAC}}$  pin.

### Synchronous LDAC

The DAC registers are updated after <u>new data</u> is read in on the falling edge of the 24th SCLK pulse. <u>LDAC</u> can be permanently low or pulsed as shown in Figure 2.

### Asynchronous **LDAC**

The outputs are not updated at the same time that the input registers are written to. When  $\overline{\text{LDAC}}$  goes low, the DAC registers are updated with the contents of the input register.

The  $\overline{\text{LDAC}}$  register gives the user full flexibility and control over the hardware  $\overline{\text{LDAC}}$  pin. This register allows the user to select which combination of channels to simultaneously update when the hardware  $\overline{\text{LDAC}}$  pin is executed. Setting the  $\overline{\text{LDAC}}$  bit register to 0 for a DAC channel means that the update of this channel is controlled by the  $\overline{\text{LDAC}}$  pin. If this bit is set to 1, this channel synchronously updates; that is, the DAC register is <u>updated</u> after new data is read in, regardless of the state of the  $\overline{\text{LDAC}}$  pin. It effectively sees the  $\overline{\text{LDAC}}$  pin as being pulled low. See Table 15 for the  $\overline{\text{LDAC}}$  register mode of operation. This flexibility is useful in applications where the user wants to simultaneously update select channels while the rest of the channels are synchronously updating.

Writing to the DAC using Command 110 loads the 2-bit  $\overline{\text{LDAC}}$  register [DB1:DB0]. The default for each channel is 0; that is, the  $\overline{\text{LDAC}}$  pin works normally. Setting the bits to 1 means the DAC register is updated, regardless of the state of the  $\overline{\text{LDAC}}$  pin. See Table 14 for contents of the input shift register during the  $\overline{\text{LDAC}}$  register setup command.

LDAC Bits (DB1 to DB0)	LDAC Pin	LDAC Operation
0	1/0	Determined by LDAC pin
1	X = don't care	The DAC registers are updated after new data is read in on the falling edge of the 24th SCLK pulse.

### INTERNAL REFERENCE SETUP

The on-chip reference is off at power-up by default. This reference can be turned on or off by setting a software programmable bit, DB0, in the control register. Table 16 shows how the state of the bit corresponds to the mode of operation. Command 111 is reserved for setting up the internal reference (see Table 8). See Table 16 for the contents of the input shift register during the internal reference setup command.

#### Table 16. Reference Setup Register

Internal Reference Setup Register (DB0)	Action
0	Reference off (default)
1	Reference on

AD5623R/AD5643R/AD5663R

# Table 17. 32-Bit Input Shift Register Contents for Reference Setup FunctionMSB

DB23 to DB22	DB21	DB20	DB19	DB18	DB17	DB16	DB15 to DB1	DB0
Х	1	1	1	Х	Х	Х	Х	1/0
Don't care	Command bits (C2 to C0)			Address bits (A2 to A0)			Don't care	Reference setup register

#### LSB

### MICROPROCESSOR INTERFACING

#### AD5623R/AD5643R/AD5663R to Blackfin<sup>®</sup> Microprocessors Interface

Figure 56 shows a serial interface between the AD5623R/ AD5643R/AD5663R and a Blackfin microprocessor such as the ADSP-BF531. The ADSP-BF531 incorporates two dual-channel synchronous serial ports, SPORT1 and SPORT0, for serial and multiprocessor communications. Using SPORT0 to connect to the AD5623R/AD5643R/AD5663R, the setup for the interface is as follows: DT0PRI drives the DIN pin of the AD5623R/ AD5643R/AD5663R, while TSCLK0 drives the SCLK of the parts. The SYNC is driven from TFS0.



Figure 56. AD5623R/AD5643R/AD5663R to Blackfin ADSP-BF531 Interface

### AD5623R/AD5643R/AD5663R to 68HC11/68L11 Interface

Figure 57 shows a serial interface between the AD5623R/ AD5643R/AD5663R and the 68HC11/68L11 microcontroller. SCK of the 68HC11/68L11 drives the SCLK of the AD5623R/ AD5643R/AD5663R, and the MOSI output drives the serial data line of the DAC.



Figure 57. AD5623R/AD5643R/AD5663R to 68HC11/68L11 Interface

The SYNC signal is derived from a port line (PC7). The setup conditions for correct operation of this interface are as follows: the 68HC11/68L11 is configured with its CPOL bit as 0, and its CPHA bit as 1. When data is being transmitted to the DAC, the SYNC line is taken low (PC7). When the 68HC11/68L11 is configured as described previously, data appearing on the MOSI output is valid on the falling edge of SCK. Serial data from the 68HC11/68L11 is transmitted in 8-bit bytes with only eight falling clock edges occurring in the transmit cycle.

Data is transmitted MSB first. To load data to the AD5623R/ AD5643R/AD5663R, PC7 is left low after the first eight bits are transferred, and a second serial write operation is performed to the DAC. PC7 is taken high at the end of this procedure.

#### AD5623R/AD5643R/AD5663R to 80C51/80L51 Interface

Figure 58 shows a serial interface between the AD5623R/ AD5643R/AD5663R and the 80C51/80L51 microcontroller. The setup for the interface is as follows: TxD of the 80C51/ 80L51 drives SCLK of the AD5623R/AD5643R/AD5663R, and RxD drives the serial data line of the part. The SYNC signal is again derived from a bit-programmable pin on the port. In this case, Port Line P3.3 is used. When data is to be transmitted to the AD5623R/AD5643R/AD5663R, P3.3 is taken low. The 80C51/ 80L51 transmit data in 8-bit bytes only; thus, only eight falling clock edges occur in the transmit cycle. To load data to the DAC, P3.3 is left low after the first eight bits are transmitted, and a second write cycle is initiated to transmit the second byte of data. P3.3 is taken high following the completion of this cycle.

The 80C51/80L51 output the serial data in a format that has the LSB first. The AD5623R/AD5643R/AD5663R must receive data with the MSB first. The 80C51/80L51 transmit routine should take this into account.



Figure 58. AD5623R/AD5643R/AD5663R to 80C512/80L51 Interface

#### AD5623R/AD5643R/AD5663R to MICROWIRE Interface

Figure 59 shows an interface between the AD5623R/AD5643R/ AD5663R and any MICROWIRE-compatible device. Serial data is shifted out on the falling edge of the serial clock and is clocked into the AD5623R/AD5643R/AD5663R on the rising edge of the SK.



Figure 59. AD5623R/AD5643R/AD5663R to MICROWIRE Interface

### **APPLICATIONS INFORMATION** USING A REFERENCE AS A POWER SUPPLY

Because the supply current required by the AD5623R/AD5643R/ AD5663R is extremely low, an alternative option is to use a voltage reference to supply the required voltage to the parts (see Figure 60). This is especially useful if the power supply is quite noisy or if the system supply voltages are at some value other than 5 V or 3 V, for example, 15 V. The voltage reference outputs a steady supply voltage for the AD5623R/AD5643R/AD5663R. If the low dropout REF195 is used, it must supply 500  $\mu$ A of current to the AD5623R/AD5643R/AD5663R, with no load on the output of the DAC. When the DAC output is loaded, the REF195 also needs to supply the current to the load. The total current required (with a 5 k $\Omega$  load on the DAC output) is

500  $\mu$ A + (5 V/5 k $\Omega$ ) = 1.5 mA

The load regulation of the REF195 is typically 2 ppm/mA, which results in a 3 ppm (15  $\mu$ V) error for the 1.5 mA current drawn from it. This corresponds to a 0.196 LSB error for the 16-bit AD5663R.



Figure 60. REF195 as Power Supply to the AD5623R/AD5643R/AD5663R

### **BIPOLAR OPERATION USING THE AD5663R**

The AD5663R has been designed for single-supply operation, but a bipolar output range is also possible using the circuit in Figure 61. The circuit gives an output voltage range of  $\pm 5$  V. Rail-to-rail operation at the amplifier output is achievable using an AD820 or an OP295 as the output amplifier.

The output voltage for any input code can be calculated as follows:

$$V_{O} = \left[ V_{DD} \times \left( \frac{D}{65,536} \right) \times \left( \frac{RI + R2}{RI} \right) - V_{DD} \times \left( \frac{R2}{RI} \right) \right]$$

where *D* represents the input code in decimal (0 to 65,535). With  $V_{DD} = 5$  V, R1 = R2 = 10 kΩ,

$$V_{\rm O} = \left(\frac{10 \times D}{65,536}\right) - 5 \text{ V}$$

This is an output voltage range of  $\pm 5$  V, with 0x0000 corresponding to a -5 V output, and 0xFFFF corresponding to a +5 V output.



### USING THE AD5663R WITH A GALVANICALLY ISOLATED INTERFACE

In process control applications in industrial environments, it is often necessary to use a galvanically isolated interface to protect and isolate the controlling circuitry from any hazardous common-mode voltages that can occur in the area where the DAC is functioning. *i*Coupler<sup>®</sup> provides isolation in excess of 2.5 kV. The AD5663R uses a 3-wire serial logic interface, so the ADuM1300 3-channel digital isolator provides the required isolation (see Figure 62). The power supply to the part also needs to be isolated, which is done by using a transformer. On the DAC side of the transformer, a 5 V regulator provides the 5 V supply required for the AD5663R.



Figure 62. AD5663R with a Galvanically Isolated Interface

### POWER SUPPLY BYPASSING AND GROUNDING

When accuracy is important in a circuit, it is helpful to carefully consider the power supply and ground return layout on the board. The printed circuit board containing the AD5663R should have separate analog and digital sections, each having its own area of the board.

If the AD5663R is in a system where other devices require an AGND-to-DGND connection, the connection should be made at one point only. This ground point should be as close as possible to the AD5663R.

The power supply to the AD5663R should be bypassed with 10  $\mu$ F and 0.1  $\mu$ F capacitors. The capacitors should be located as close as possible to the device, with the 0.1  $\mu$ F capacitor ideally right up against the device. The 10  $\mu$ F capacitors are the tantalum bead type. It is important that the 0.1  $\mu$ F capacitor have low effective series resistance (ESR) and effective series inductance (ESI), which is found, for example, in common ceramic types of capacitors.

This 0.1  $\mu$ F capacitor provides a low impedance path to ground for high frequencies caused by transient currents due to internal logic switching.

The power supply line itself should have as large a trace as possible to provide a low impedance path and to reduce glitch effects on the supply line. Clocks and other fast switching digital signals should be shielded from other parts of the board by digital ground. Avoid crossover of digital and analog signals, if possible. When traces cross on opposite sides of the board, ensure that they run at right angles to each other to reduce feedthrough effects through the board. The best board layout technique is the microstrip technique, where the component side of the board is dedicated to the ground plane only and the signal traces are placed on the solder side. However, this is not always possible with a 2-layer board.

### **OUTLINE DIMENSIONS**



### **ORDERING GUIDE**

			Internal		Package	
Model <sup>1</sup>	Temperature Range	Accuracy	Reference	Package Description	Option	Branding
AD5623RBCPZ-3R2	-40°C to +105°C	±1 LSB INL	1.25 V	10-Lead LFCSP_WD	CP-10-9	D85
AD5623RBCPZ-3REEL7	-40°C to +105°C	±1 LSB INL	1.25 V	10-Lead LFCSP_WD	CP-10-9	D85
AD5623RBCPZ-5REEL7	-40°C to +105°C	±1 LSB INL	2.5 V	10-Lead LFCSP_WD	CP-10-9	D86
AD5623RBRMZ-3	-40°C to +105°C	±1 LSB INL	1.25 V	10-Lead MSOP	RM-10	D85
AD5623RBRMZ-3REEL7	-40°C to +105°C	±1 LSB INL	1.25 V	10-Lead MSOP	RM-10	D85
AD5623RBRMZ-5	-40°C to +105°C	±1 LSB INL	2.5 V	10-Lead MSOP	RM-10	D86
AD5623RBRMZ-5REEL7	-40°C to +105°C	±1 LSB INL	2.5 V	10-Lead MSOP	RM-10	D86
AD5623RACPZ-5REEL7	-40°C to +105°C	±2 LSB INL	2.5 V	10-Lead LFCSP_WD	CP-10-9	DKB
AD5623RARMZ-5REEL7	-40°C to +105°C	±2 LSB INL	2.5V	10-Lead MSOP	RM-10	DKP
AD5623RARMZ-5	-40°C to +105°C	±2 LSB INL	2.5V	10-Lead MSOP	RM-10	DKP
AD5643RBRMZ-3	-40°C to +105°C	±4 LSB INL	1.25 V	10-Lead MSOP	RM-10	D81
AD5643RBRMZ-3REEL7	-40°C to +105°C	±4 LSB INL	1.25 V	10-Lead MSOP	RM-10	D81
AD5643RBRMZ-5	-40°C to +105°C	±4 LSB INL	2.5 V	10-Lead MSOP	RM-10	D7Q
AD5643RBRMZ-5REEL7	-40°C to +105°C	±4 LSB INL	2.5 V	10-Lead MSOP	RM-10	D7Q
AD5663RBCPZ-3R2	-40°C to +105°C	±16 LSB INL	1.25 V	10-Lead LFCSP_WD	CP-10-9	D7S
AD5663RBCPZ-3REEL7	-40°C to +105°C	±16 LSB INL	1.25 V	10-Lead LFCSP_WD	CP-10-9	D7S
AD5663RBCPZ-5REEL7	-40°C to +105°C	±16 LSB INL	2.5 V	10-Lead LFCSP_WD	CP-10-9	D7H
AD5663RBRMZ-3	-40°C to +105°C	±16 LSB INL	1.25 V	10-Lead MSOP	RM-10	D7S
AD5663RBRMZ-3REEL7	-40°C to +105°C	±16 LSB INL	1.25 V	10-Lead MSOP	RM-10	D7S
AD5663RBRMZ-5	-40°C to +105°C	±16 LSB INL	2.5 V	10-Lead MSOP	RM-10	D7H
AD5663RBRMZ-5REEL7	-40°C to +105°C	±16 LSB INL	2.5 V	10-Lead MSOP	RM-10	D7H
EVAL-AD5663REBZ				Evaluation Board		

 $^{1}$  Z = RoHS Compliant Part.

# NOTES

### NOTES



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